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19.1 A 240W Monolithic Class-D Audio Amplifier

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The audio amplifier market continuously demands improved performance at low cost. Apart from reliability, 3 performance criteria are of main interest: output power, idle loss and THD. Low THD should preferably be achieved open-loop, since a feedback loop cannot be easily added if the signal path is fully digital. For an integrated Class-D amplifier as shown in Fig. 19.1.1, all 3 performance criteria are influenced primarily by the timing and electrical characteristics of the gate drives, i.e., the circuits that drive the gates of the output switches. The input is a PWM audio signal, reproduced by the output stage at the V\text{OUT} node. The external lowpass filter, I\text{OUT} and C\text{OUT}, reconstructs the analog audio signal on the loudspeaker terminal. The filter must be close to critically damped with a 4 to 8\text{Ω} load and provide maximum attenuation of the PWM carrier. This means that no degrees of freedom are left in its design, and I\text{OUT} after C\text{OUT} are considered fixed in the following. The influences of the gate drive output characteristics on each of the 3 main performance criteria are discussed below.

The V\text{DD} voltage rating of the output LDMOS devices Q0 and Q1 (Fig. 19.1.2) sets a hard limit on the output power that can be delivered to a given load resistance. The supply voltage V\text{DD} must be less than the device V\text{DS} voltage rating by an amount large enough to account for the inevitable switching voltage overshoots. The size of the gate drive pull-down devices Q2 and Q4 influences the switching overshoots, and thus the achievable output power. For a rising-edge transition with a large output current I\text{OUT}, the voltage at the output node V\text{OUT} exceeds V\text{DD} while the current builds up in the parasitic inductance L\text{D2D} of the power-supply decoupling network. Neglecting all parasitic capacitances other than C\text{GD} (which is acceptable for LDMOS transistors working in the saturation region), it can be shown that the peak drain-source voltage V\text{DS,Q0} for Q0 can be approximated by

\[ V\text{DS,Q0} = V\text{DD} + \sqrt{I\text{OUT} \cdot \frac{2 \cdot V\text{DD} \cdot V_{\text{GS},Q0}}{R_{\text{DS,Q0}}}} \]  

(1)

where C\text{GD} is the gate-drain capacitance of Q0 or Q1 (considered identical), V\text{GS,Q0} is the gate-source voltage required by Q0 to conduct I\text{OUT} (neglecting the fraction of I\text{OUT} flowing into C\text{GD,Q0}), and R\text{DS,Q0} is the channel resistance of Q2. It is clear that the second term in (1) can be reduced by increasing R\text{DS,Q0}, i.e., by reducing the width of the gate drive pull-down device Q2. This allows the use of a higher V\text{DD} without exceeding device ratings, which in turn increases the achievable output power. Symmetrical conditions result in the same dependence of V\text{DS,Q0} on the width of Q4. Another important performance parameter for Class-D amplifiers is idle power losses, which must be kept low, since the noise of a cooling air fan cannot be tolerated at low music volume. During idle operation, I\text{OUT} equals the switching ripple current (see Fig. 19.1.3). For each rising-edge transition, I\text{OUT} will charge the output node V\text{OUT} towards V\text{DD} right after Q0 is turned off. This charging process is referred to as autocommutation, and is almost lossless, since charge is merely moved from C\text{GD,Q1} to C\text{GD,Q0}. However, if the current in C\text{GD,Q1} is large enough to cause a voltage drop across Q2 which exceeds the Q0 threshold voltage V\text{t}, Q0 will conduct part of I\text{OUT}, and the resulting power dissipation in Q0 will increase power losses. It can easily be shown that this loss is avoided if:

\[ R_{\text{DS,Q1}} < \frac{16 \cdot V_{\text{f},Q} \cdot I_{\text{OUT}}}{V_{\text{DD}}} \]  

(2)

(and similarly for R\text{DS,Q2} for the falling edge transition). This leads to an important design tradeoff for higher output power: Since a higher-power output stage must operate from a larger V\text{DD} voltage, the widths of Q2 and Q4 must be increased to satisfy (2) and maintain low idle losses. However, this increases the overshoot voltages as given by (1). This effect is further accelerated by a larger I\text{OUT}, and causes diminishing returns in terms of the output power achievable from higher voltage process nodes.

Low power losses also require avoiding any overlap between the conduction times for Q0 and Q1 during transitions. It has been shown that this sets an upper bound on the ratio R\text{DS,Q1}/R\text{DS,Q2} (and similarly R\text{DS,Q2}/R\text{DS,Q1}) [1], as indicated in Fig. 19.1.3. This is not a major constraint, since it can be achieved simply by selecting a sufficiently small width for Q3 and Q5, a change that does not affect (1) or (2). Since the present design uses N-type devices for Q3 and Q5, these transistors operate in the saturated region when turning on Q0 and Q1, and the above requirement on the channel resistances should instead be applied to the ratios of the respective drive currents. Moreover, it can be shown that this ratio bound must be obeyed not only for the zero dead time approach presented in [1], but also to avoid conduction overlap in systems with finite dead time τ\text{D}. The requirement causes the switch timing in the output stage to become asymmetrical, since Q6 and Q1 are now turned on more slowly than they are turned off. Given such an asymmetry, it can be shown that the minimum THD is obtained for a finite value of τ\text{D}, contrary to the common assumption that THD always increases with dead time (e.g., see [2]). Through careful optimization of the τ\text{D}-versus-Q2/Q3 (Q4/Q5) ratio, the open-loop THD performance shown in Fig. 19.1.4 has been obtained.

The amplifier was implemented in a 0.4µm/1.8µm P-bulk high-voltage BiCMOS process with 2 Al and 1 Cu metal layers. For each of the 2 half bridges, 3 pins are used for each of the terminals VDD, GND and OUT, and multiple bond wires connect each of these pins to the die, in order to ensure adequate current handling and reduce conduction power losses. The chip contains two half bridges, and when used in bridge tied load (BTL) configuration, the unclipped output power is 244W into 4Ω. To the best of our knowledge, this power level is unprecedented for monolithic output stages. While the output power is conventionally measured on a purely resistive load, a 4Ω loudspeaker is a complex load and requires additional current. To accommodate this need, the amplifier is designed to provide at least ±18A of output current during normal operation (see Fig. 19.1.5). Currents above this level will cause the output stage to automatically invert the amplifier, thereby protecting the power stage and reducing distortion. Additionally, the amplifier includes a short circuit protection circuit that turns off the output stage in the event of an inadvertent short circuit at the output node.

\[
R_{DS,Q1} < \frac{16 \cdot V_{f,Q} \cdot I_{OUT}}{V_{DD}}
\]

References:

Acknowledgements:

The chip was designed by the Digital Audio design team at Texas Instruments, section manager Sreenath Unnikrishnan and design manager Dale J. Shelton, TI Fellow.
Figure 19.1.1: Single-rail Class-D output stage (one half bridge shown).

Figure 19.1.2: Half bridge output stage detail.

Figure 19.1.3: Switching waveforms during idle operation.

Figure 19.1.4: THD+N measurement.

Figure 19.1.5: Output current capability.

Figure 19.1.6: Performance summary.

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**Table:**

<table>
<thead>
<tr>
<th>Output power</th>
<th>V&lt;sub&gt;DD&lt;/sub&gt;=50V</th>
</tr>
</thead>
<tbody>
<tr>
<td>133W</td>
<td>8Ω, unclipped, T&lt;sub&gt;c&lt;/sub&gt;=75°C</td>
</tr>
<tr>
<td>176W</td>
<td>8Ω, 10% THD, T&lt;sub&gt;c&lt;/sub&gt;=75°C</td>
</tr>
<tr>
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<td>4Ω, unclipped, T&lt;sub&gt;c&lt;/sub&gt;=75°C</td>
</tr>
<tr>
<td>322W</td>
<td>4Ω, 10% THD, T&lt;sub&gt;c&lt;/sub&gt;=75°C</td>
</tr>
</tbody>
</table>

**V<sub>DD</sub> idle current:**

| 42mA |

**THD+N:**

| <0.07 % | 8Ω |
| <0.10 % | 4Ω, see Figure 19.1.4 |

**Noise:**

| -110dBA | Not limited by the output stage. -110dB (A-weighted) is achievable with a TI TAS5518 PWM modulator |

**Output current capability:**

| ± 18A | See Figure 19.1.5 |
Figure 19.1.7: Die micrograph. The two half bridges form one bridge tied output.
Figure 19.1.1: Single-rail Class-D output stage (one half bridge shown).
Figure 19.1.2: Half bridge output stage detail.
Figure 19.1.3: Switching waveforms during idle operation.
Figure 19.1.4: THD+N measurement.
Figure 19.1.5: Output current capability.

11A\textsubscript{p} needed for 244W @ 4\Omega

1 period of 1kHz sine wave
<table>
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<tr>
<th>Output power ( V_{DD} = 50\text{V} )</th>
<th>133W</th>
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<td>322W</td>
<td>( 4\Omega, 10% \text{THD}, \ Tc=75^\circ\text{C} )</td>
</tr>
<tr>
<td>( V_{DD} ) idle current</td>
<td>42mA</td>
<td>( V_{DD}=50\text{V}, \ f_s=384\text{kHz}, \ L_{OUT}=10\mu\text{H}, \ Tc=25^\circ\text{C} )</td>
</tr>
<tr>
<td>THD+N</td>
<td>&lt;0.07 %</td>
<td>( 8\Omega )</td>
</tr>
<tr>
<td></td>
<td>&lt;0.10 %</td>
<td>( 4\Omega, \text{see Figure 19.1.4} )</td>
</tr>
<tr>
<td>Noise</td>
<td>-110dB</td>
<td>Not limited by the output stage. -110dB (A-weighted) is achievable with a TI TAS5518 PWM modulator</td>
</tr>
<tr>
<td>Output current capability</td>
<td>( \pm 18\text{A} )</td>
<td>See Figure 19.1.5</td>
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</tbody>
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